

32 kHz–100 MHz CMEMS® OSCILLATOR

Features

- Wide frequency range: 32 kHz to 100 MHz
 - Contact Silicon Labs for frequencies above 100 MHz
- Si501 single frequency w/ OE
- Si502 dual frequency w/ OE/FS
- Si503 quad frequency w/ FS
- $\pm 20/30/50$ ppm frequency stability including 10-year aging
- LVCMOS output
- Low period jitter
- Low power
- Continuous supply voltage range: +1.71 V to +3.63 V
- User selectable tRise/tFall options
- Glitchless start and stop
- Excellent short-term stability, long-term aging
- Industry standard footprints: 2x2.5, 2.5x3.2, 3.2x5 mm
- RoHS compliant, Pb-free
- Short lead times: <2 weeks
- -20 to $+70$ °C: Extnd commercial
- -40 to $+85$ °C: Industrial
- The Si50x family also includes the Si504 for in-circuit programmability (See the Si504 Data Sheet)

Applications

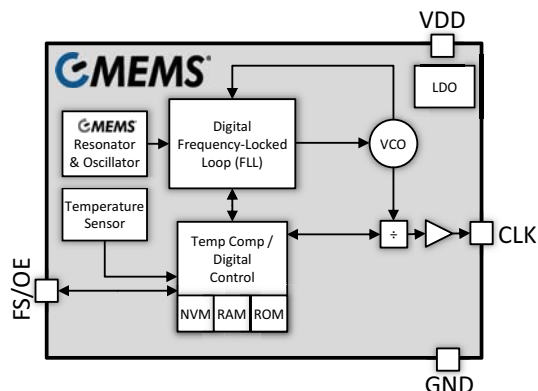
- Storage (SATA/SAS/PCIe)
- General purpose processors
- Industrial controllers
- Embedded controllers
- Motor control
- Flow control
- Office/Home automation
- IP cameras/surveillance
- Display and control panels
- Outdoor electronics
- Multi-function printers
- Office equipment

Description

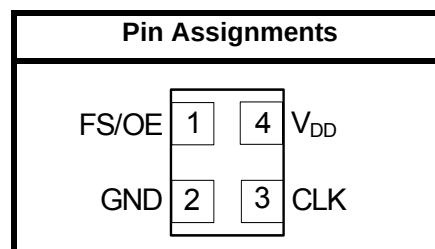
The Si501/2/3 CMEMS oscillator family provides monolithic, MEMS-based IC replacements for traditional crystal oscillators. Silicon Laboratories' CMEMS technology combines standard CMOS + MEMS in a single, monolithic IC to provide integrated, high-quality and high-reliability oscillators. Each device is factory tested and configured for guaranteed performance to data sheet specifications across voltage, process, temperature, shock, vibration, and aging.

Additional information on the Si50x CMEMS oscillator architecture and CMEMS technology is available in white papers on the Silicon Labs website at www.siliconlabs.com/cmems.

Functional Block Diagram



Ordering Information:
See Section 5.



Patents pending

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1. Electrical Specifications

Table 1. Recommended Operating Conditions
 V_{DD} =1.71 to 3.63 V, T_A = -40 to 85 °C, unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Supply Voltage ¹	V_{DD}		1.71	—	3.63	V
Supply Current	I_{DD1}	C_L =4 pF, 3.3 V_{DD} , F_{CLK} =1.0 MHz, low power option	—	1.7	2.5	mA
		C_L =4 pF, 3.3 V_{DD} , F_{CLK} =100 MHz, low power option	—	5.3	6.5	mA
		C_L =4 pF, 3.3 V_{DD} , F_{CLK} =1.0 MHz, low jitter option	—	3.9	4.9	mA
		C_L =4 pF, 3.3 V_{DD} , F_{CLK} =100 MHz, low jitter option	—	7.6	8.9	mA
Static Supply Current	I_{DD2}	Mode=Stop ² , low power option F_{CLK} =1 MHz	—	1.7	2.5	mA
		Mode=Stop ² , low jitter option F_{CLK} =1 MHz	—	3.9	4.9	mA
		Mode=Doze ²	—	670	890	μA
		Mode=Sleep ²	—	0.3	1	μA
Input High Voltage	V_{IH}	FS/OE pin	0.70 x V_{DD}	—	—	V
Input Low Voltage	V_{IL}	FS/OE pin	—	—	0.30 x V_{DD}	V
OE Internal Pull Resistor	R_I	Ordering option	40	50	60	kΩ
Operating Temperature	T_A	Extended commercial grade	-20	—	70	°C
		Industrial grade	-40	—	85	°C

Notes:

1. The supply voltage range is continuous from 1.71 to 3.63 V.
2. Si501 and Si502 only. Si503 has FS only and does not support Stop, Doze, or Sleep. See Section 3. Functional Description for more information on operational modes.

Table 2. Output Clock CharacteristicsV_{DD}=1.71 to 3.63 V, T_A= -40 to 85 °C, unless otherwise specified.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency Range	F _{CLK}		0.032	—	100	MHz
Clock Period	T _{CLK}	1/F _{CLK}	31,250	—	10	ns
Total Stability ¹	F _{STAB}		-20	—	+20	ppm
			-30	—	+30	ppm
			-50	—	+50	ppm
Initial Accuracy	F _I	Measured at 25 °C at the time of shipping	—	±2	—	ppm
Startup Time ²	T _{SU}	From V _{DD} crossing 1.71 V to first clock output	—	2.5	4	ms
Resume Time ^{3,4}	T _{RUN}	From Sleep mode	—	2.5	5	ms
		From Doze mode	—	1.7	2.55	ms
		From Stop mode ⁵	—	—	1.5 x T _{CLK} + 35	ns
Output Disable Time ^{3,4}	T _D	To Sleep/Doze mode, from output running	—	—	225	μs
		To Stop, from output running	—	—	1.5 x T _{CLK} + 35	ns
Frequency Update Time ^{4,6}	T _{NEW_FREQ}		—	—	5	ms

Notes:

1. Orderable option. Stability budget consists of initial tolerance, operating temperature range, rated power supply voltage change, load change, 10-year aging, shock, and vibration.
2. Hold FS/OE high (strong or weak) during powerup for fastest time to clock.
3. Si501 and Si502 only. Si503 has FS only and does not support Stop, Doze, or Sleep.
4. Asserted FS/OE actions must be held stable for the maximum duration of the invoked FS/OE event (e.g., T_{RUN}, T_{NEW_FREQ}, T_D, etc).
5. If the Si502 frequency is switched while the device is in Stop mode, the frequency prior to Stop will be output briefly until the glitchless switch to the other frequency. Doze mode and Sleep mode do not have this behavior.
6. Si502 and Si503 only. Si501 is a single frequency device with OE only.

Table 3. Output Clock Levels and Symmetry
 $V_{DD} = 1.71$ to 3.63 V, $T_A = -40$ to 85 °C unless otherwise indicated.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output High Voltage	V_{OH}	1st ordering option code: A and H $I_{OH} = -4$ mA	$0.90 \times V_{DD}$	—	—	V
Output Low Voltage	V_{OL}	1st ordering option code: A and H $I_{OH} = +4$ mA	—	—	$0.10 \times V_{DD}$	V
Rise/Fall Time ¹	tRise /tFall	1 st ordering option code ² : A and H $Z_0 = 25 \Omega @ 3.3$ V	0.4	0.7^2	1.2	ns
		1 st ordering option code: B and J $Z_0 = 50 \Omega @ 3.3$ V	1	1.3	1.6	ns
		1 st ordering option code: C and K $Z_0 = 50 \Omega @ 2.5$ V	1	1.3	1.6	ns
		1 st ordering option code: D and L $Z_0 = 50 \Omega @ 1.8$ V	1	1.3	1.6	ns
		1 st ordering option code: E and M $Z_0 = 110 \Omega @ 3.3$ V	2	3	4	ns
		1 st ordering option code: F and N $Z_0 = 220 \Omega @ 3.3$ V ³	4	5	7	ns
		1 st ordering option code: G and P $Z_0 = 440 \Omega @ 3.3$ V ³	7	8	11	ns
Duty Cycle	DC	Drive strength selected such that tRise/tFall (20% to 80%) < 10% of period	45	50	55	%
Notes: $C_L = 15$ pF, tRise/tFall (20% to 80%), 3.3 V, unless otherwise stated. - Recommended series termination resistor (R_S) = 24.9Ω for $Z_0 = 50 \Omega$. - Ordering options F, N, G, and P are not recommended for $F_{CLK} > 5$ MHz.						

Table 4. Output Clock Jitter and Phase NoiseV_{DD} = 1.71 to 3.63 V, T_A = –40 to 85 °C unless otherwise indicated.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Cycle-to-Cycle Jitter	J _{CCPP}	100 MHz, Low Jitter Option 1 st ordering option code: H	—	14	25	ps pk-pk
		100 MHz, Low Power Option 1 st ordering option code: A	—	16	26	ps pk-pk
Period Jitter	J _{PRMS}	100 MHz, Low Jitter Option 1 st ordering option code: H	—	1	1.6	ps rms
		100 MHz, Low Power Option 1 st ordering option code: A	—	1.3	1.9	ps rms
Period Jitter Pk-Pk	J _{PPKPK}	Low Jitter Option 10k samples 1 st ordering option code: H	—	9	13	ps pk-pk
		Low Power Option 10k samples 1 st ordering option code: A	—	10	16	ps pk-pk
Phase Jitter ¹	ϕ	75 MHz F _{OFFSET} =900 kHz to 7.5 MHz Low Jitter Option 1 st ordering option code: H	—	1	1.3	ps rms
		75 MHz F _{OFFSET} =900 kHz to 7.5 MHz Low Power Option 1 st ordering option code: A	—	2.5	3.2	ps rms

Notes:

1. Integrated phase jitter exceeds the requirements of some high-performance data communications systems. See AN783 for additional information.

Table 5. Environmental Compliance and Package Information

Parameter	Test Condition
Mechanical Shock	MIL-STD-883, Method 2002, Cond B. (1,500 g)
Mechanical Shock High g	MIL-STD-883, Method 2002, Cond E. (10,000 g)
Mechanical Vibration	MIL-STD-883, Method 2007
Solderability	MIL-STD-883, Method 2003
Temperature Cycle	JESD22, Method A104
Resistance to Solder Heat	MIL-STD-883, Method 2036
Contact Pads	Gold over Nickel/Palladium

Table 6. Thermal Conditions

Parameter	Symbol	Test Condition	Value	Unit
Thermal Impedance	θ_{JA}	3.2x5 mm, still air	187	°C/W
		2.5x3.2 mm, still air	239	
		2x2.5 mm, still air	241	

Table 7. Absolute Maximum Limits¹

Parameter	Symbol	Rating	Unit
Maximum Operating Temperature	T_{MAX}	85	°C
Storage Temperature	T_S	-55 to +125	°C
Supply Voltage	V_{DD}	-0.5 to +3.8	V
Input Voltage	V_{IN}	-0.5 to V_{DD} +0.3V	V
ESD Sensitivity (JESD22-A114)	HBM	2000	V
ESD Sensitivity (CDM)	CDM	500	V
Soldering Temperature (Pb-free profile) ²	T_{PEAK}	260	°C
Soldering Time at T_{PEAK} (PB-free profile) ²	T_P	20–40	s
Junction Temperature	T_J	125	°C

Notes:

1. Stresses beyond those listed in this table may cause permanent damage to the device. Functional operation specification compliance is not implied at these conditions. Exposure to maximum rating conditions for extended periods may affect device reliability.
2. The device is compliant with JEDEC J-STD-020.

2. Si501/2/3 Typical Applications Circuits, AC Waveforms, and Functional Descriptions

The Si501/2/3 family has various applications circuits and ac waveforms depending on the selected device and ordering configuration options. Pay careful attention when reading the following section to be sure you refer to the correct diagrams.

2.1. Si501/2 Applications Circuits

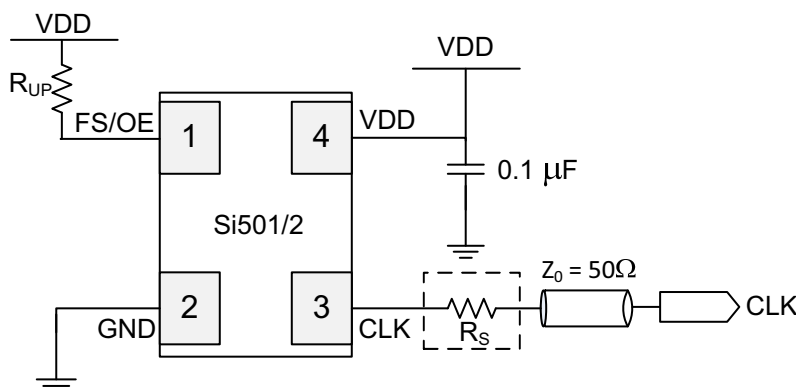


Figure 1. Si501/2 Applications Circuit with Optional Output Series Resistor

Note: The dotted line box in Figure 1 is an optional component depending on tRise/tFall configuration option. This diagram applies to all Si50x product drive strength configuration options. See Table 3 for R_S recommendations. See Section 5. "Ordering Guide" for configuration options.



Note: The dotted line boxes in Figure 2 show resistor options depending on MCU pull-up resistors configuration and the Si501/2 internal resistor configuration options. See Section 5. "Ordering Guide" for configuration options. Users should design only one of the pin 1 dotted-line options. The series resistor (R_S) on pin 3 is also optional. See Table 3 for R_S recommendations.

Figure 2. Si501/2 Applications Circuit with MCU Configuration Options

Table 8. Si502 FS/OE States and Resistor Values

FS/OE Pin State	R_{UP}	Clock Output
Strong High	$0\ \Omega \leq R_{UP} \leq 1\ k\Omega$	Frequency 1
Weak High	$20\ k\Omega \leq R_{UP} \leq 200\ k\Omega$	Frequency 2
Low	—	Hi-Z

Notes:

1. If the Si502 internal pull-up resistor configuration option is not selected, an MCU internal pull-up resistor or an external pull-up resistor should be used.
2. The parallel combination of all pull-up resistors on the FS/OE pin, including the optional internal device pull-up resistor must be $> 20\ k\Omega$ to select the Weak High state.
3. If the Si502 internal pull-up resistor is enabled with no other external FS/OE connections, the FS/OE state will be detected as 'Weak High' which selects the Frequency 2 output by default.

2.2. Si501/2 AC Waveforms and Functional Descriptions

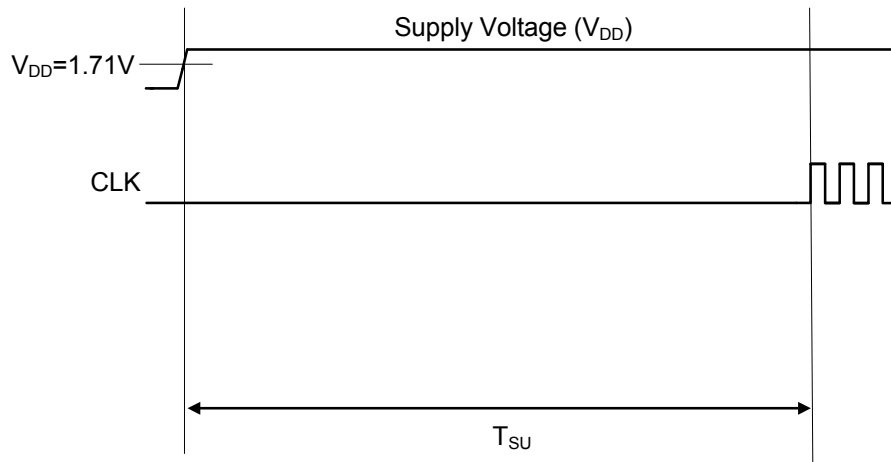


Figure 3. Si501/2 Power On Time (refer to Table 2)

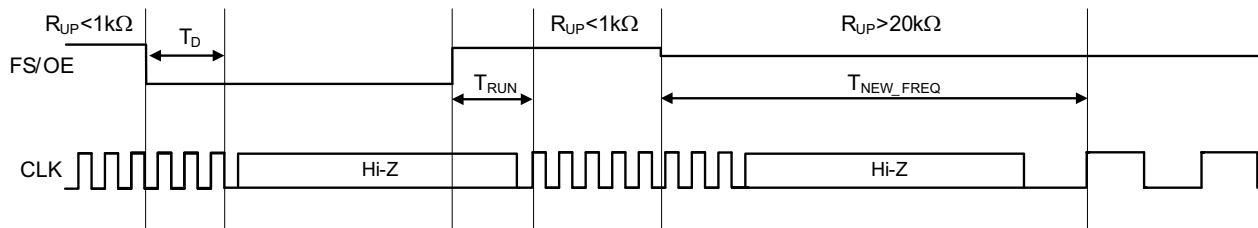
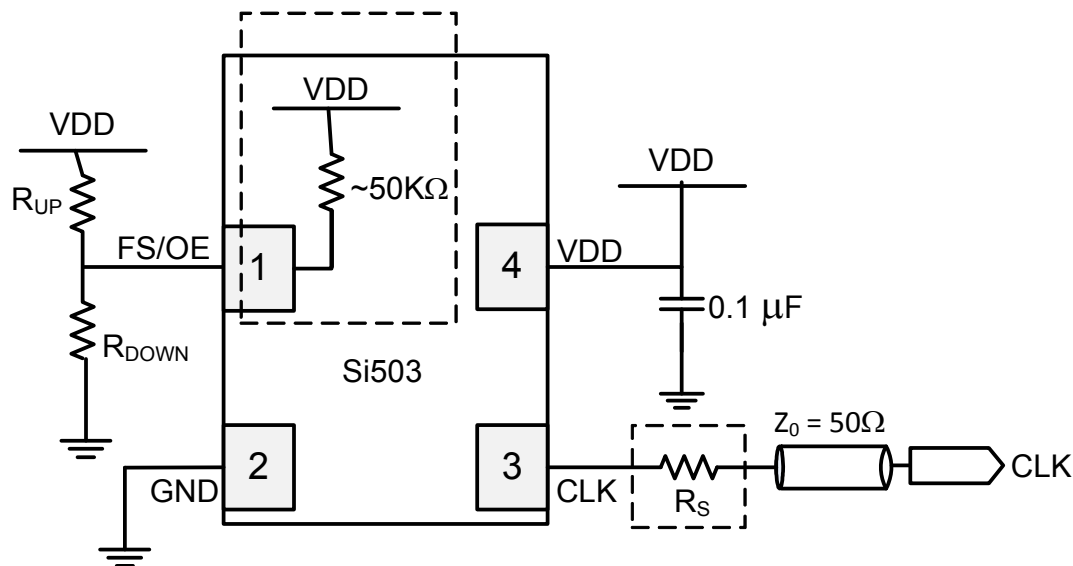


Figure 4. Si501/2 AC Waveform (refer to Table 2)

2.3. Si503 Applications Circuits



Note: The dotted line boxes show optional components depending on t_{Rise}/t_{Fall} and internal pull up resistor configuration options. See Section 5. "Ordering Guide" for configuration options. See Table 3 for R_S recommendations.

Figure 5. Si503 Applications Circuit with Configuration Options

Table 9. Si503 Frequency Select with External Resistor Options

FS/OE Pin State	R _{UP}	R _{DOWN}	Clock Output
Strong High	$0\ \Omega \leq R_{UP} \leq 1\ \text{k}\Omega$	Do not populate	Frequency 1
Weak High	$20\ \text{k}\Omega \leq R_{UP} \leq 200\ \text{k}\Omega$	Do not populate	Frequency 2
Weak Low	Do not populate	$20\ \text{k}\Omega \leq R_{DOWN} \leq 200\ \text{k}\Omega$	Frequency 3
Strong Low	Do not populate	$0\ \Omega \leq R_{DOWN} \leq 1\ \text{k}\Omega$	Frequency 4
Note: If the Si503 internal pull-up resistor is enabled with no other external FS/OE connections, the FS/OE state will be detected as 'Weak High' which selects the Frequency 2 output by default.			



Note: The dotted line boxes in Figure 6 show resistor options depending on MCU pull-up resistors configuration and the Si503 internal resistor configuration options. See Section 5. "Ordering Guide" for configuration options. Users should design only one of the pin 1 dotted-line options. The series resistor (R_S) on pin 3 is also optional. See Table 3 for R_S recommendations.

Figure 6. Si503 Applications Circuit with MCU and Configuration Options

Table 10. Si503 Frequency Select

FS/OE Pin State	MCU Output 1	MCU Output 2	Clock Output
Strong High	High	Hi-Z	Frequency 1
Weak High	Hi-Z	Hi-Z	Frequency 2
Weak Low	Hi-Z	Low	Frequency 3
Strong Low	Low	Hi-Z	Frequency 4

Note: If the Si50x internal pull-up resistor is enabled with no other external OE connections, the OE state will be detected as 'Weak High' which selects the Frequency 2 output by default.

2.4. Si503 AC Waveform and Functional Description



Figure 7. Si503 Power On Time (refer to Table 2)



Figure 8. Si503 AC Waveform (refer to Table 2)

3. Functional Description

The Si50x series oscillator family includes four base devices. All devices are configurable according to the Section 5. "Ordering Guide". The four devices each support a single clock output frequency at any one time and are segmented according to the number of clock frequencies they store in on-chip memory.

The Si501 supports a single stored frequency, enabled with the OE functionality. The Si502 stores two frequencies that can be selected with FS and enabled/disabled with OE functionality. The Si503 stores four frequencies, selected with FS functionality. The Si503 does not support OE functionality. The Si501/2/3 are covered in this data sheet.

The Si504 is a programmable oscillator, controlled through a single pin interface (C1D). It is covered in its own Si504 data sheet available at www.siliconlabs.com/cmems.

All devices in the Si50x CMEMS series employ a cost-optimized, power-efficient, digital FLL architecture to produce a highly accurate and stable output clock from a passively compensated MEMS resonator reference frequency.

The architecture uses the MEMS resonator as its reference frequency along with a divided signal from an on-chip, digitally-controlled VCO to drive a frequency comparator for the FLL's digital loop filter. The digital loop filter accumulates and further processes the frequency error values to produce the target output frequency.

The architecture also uses a high-resolution, low-noise temperature sensor and temperature compensation algorithm to offset any temperature drift of the passively compensated MEMS resonator. Each device is calibrated for temperature and MEMS-resonator frequency pairs and derives a device-specific compensation polynomial. As the temperature changes, this compensation circuitry offsets any frequency drift.

This tightly coupled system is extremely accurate and fast because the MEMS resonator and CMOS compensation circuitry are in a single, monolithic chip, and, therefore, separated by a few microns.

The complete system process occurs many thousands of times per second, providing excellent frequency accuracy and stability across temperature changes, including any fast temperature transients. The oscillator also supports a low-power version that reduces the sampling cycle to a longer period, reducing power consumption for applications that can tolerate relaxed jitter specifications of approximately 1 ps RMS to reduce power by approximately 2-3 mA. See Table 1 for exact specifications.

3.1. OE Enable and Disable States

The Si50x CMEMS series supports four operational output states via the FS/OE configuration pin. If enabled, the Si50x is in Run mode, the clock is output and power is as specified in Table 1. The disable modes are Stop, Sleep, and Doze. Each of these states has a different power consumption profile as specified in Table 1.

3.1.1. Stop Mode

The Si50x output in Stop mode is high-impedance, also known as High-Z (Hi-Z) or Tri-State. Stop mode disables the output driver, but the digital core and MEMS resonator remain enabled for fast transition to Run mode. The output is stopped and held at High-Z after completing the last cycle glitch-free. No other power saving measure is taken in Stop mode.

3.1.2. Doze Mode

The Si50x output in Doze mode is high-impedance, also known as High-Z (Hi-Z) or Tri-State. Doze mode disables the output driver, the VCO, and the MEMS resonator, but the digital core remains enabled. The output is stopped and is held at High-Z after completing the last cycle glitch-free.

3.1.3. Sleep Mode

The Si50x output in Sleep mode is high-impedance, also known as High-Z (Hi-Z) or Tri-State. Sleep mode disables power to all circuitry except for low-leakage circuitry that retains the last device configuration. The output is stopped and is held at High-Z after completing the last cycle glitch-free.

3.2. Output Rise and Fall Settings

The Si50x clock output is programmable. This enables reduction of electromagnetic interference (EMI) radiation from the clock output. The amount of EMI reduction is dependent on the output frequency, the harmonic of interest, and the board layout. Lab results using a 50 MHz FOUT and changing the clock tRise/tFall time from 0.7 ns to 8 ns show up to 14 dB of EMI reduction.

The tRise/tFall feature also allows the Si50x to match competing devices' rise and fall times. Crystal oscillator tRise/tFall behavior is largely dependent on the supply voltage. In crystal-based oscillators, a higher supply voltage will generally drive a more rapid tRise/tFall time. The Si50x configuration options allow the user to match the tRise/tFall to the supply voltage. The Si50x also provides a specified tRise/tFall with a given supply voltage and a 50 Ω trace impedance. See Table 3 for Si50x tRise/tFall specifications.

4. Pin Descriptions



Figure 9. Si501/2/3

Table 11. Pin Description

Pin	Name	Function
1	FS/OE	FS=Frequency Select. Si502 and Si503 only. OE=Output Enable. Si501 and Si502 only.
2	GND	Ground.
3	CLK	Output clock.
4	V _{DD}	Power supply. Bypass with a 0.1 μ F capacitor placed as close to the V _{DD} pin as possible.

5. Ordering Guide

The Si50x family of CMEMS oscillators are highly configurable. Each orderable part number must be specified according to the guidelines below. Each customized part's performance is guaranteed to operate within the data sheet specifications. An on-line configuration and ordering tool is available at www.siliconlabs.com/cmems.

5.1. Si501 Ordering Guide and Part Number Syntax



Note:

1. Series termination resistor (R_S) is recommended for this configuration. See Table 3 and Section 2.
2. Series termination resistor is not needed for this configuration. Output impedance is 50 Ω for the indicated supply condition.
3. Series termination resistor is not needed for this configuration. Reduced EMI setting.
4. Silicon Labs 3.2 x 5 mm package is delivered as 3.2 x 4 mm and accommodates the industry-standard 3.2 x 5 mm footprint.

Figure 10. Si501 Part Number Syntax

5.2. Si502 Ordering Guide and Part Number Syntax

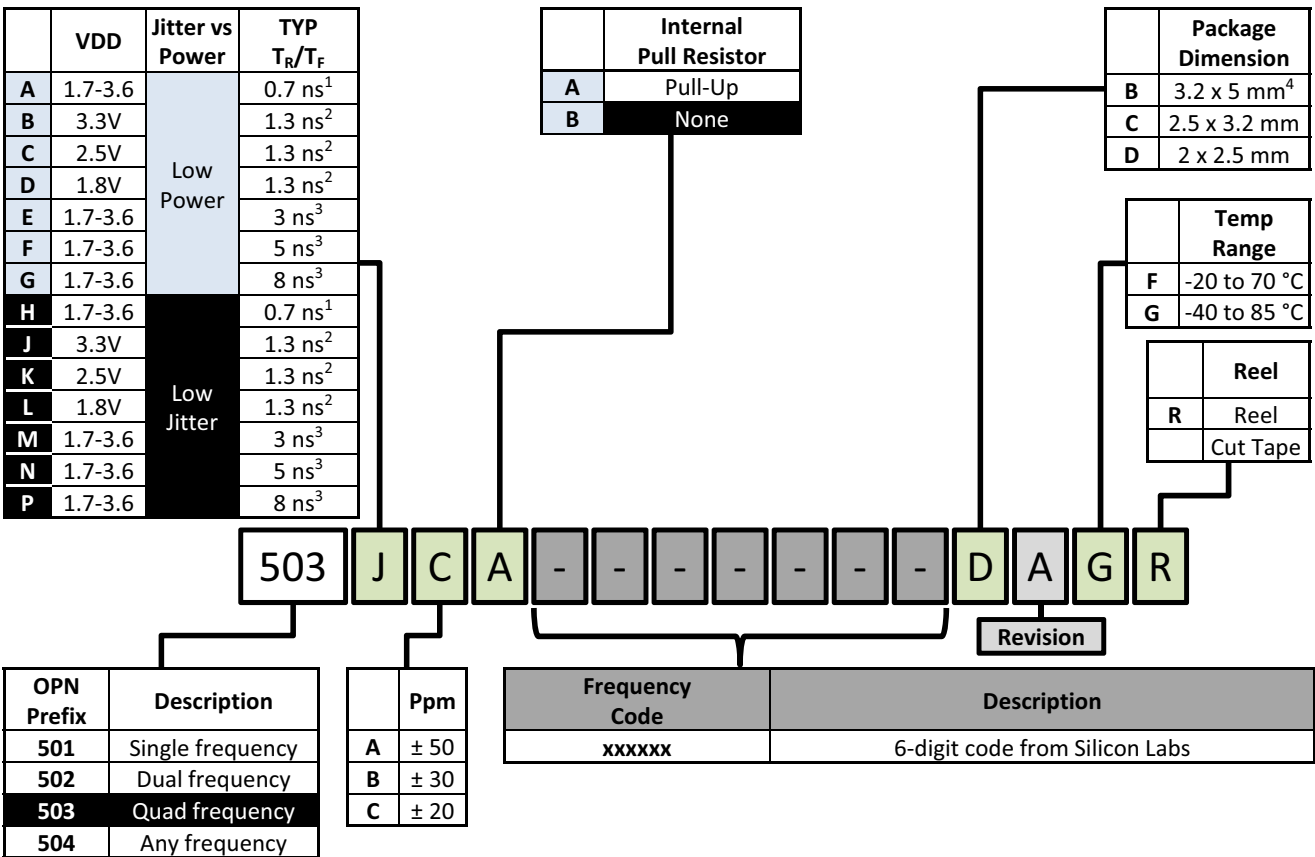


Note:

1. Series termination resistor (R_S) is recommended for this configuration. See Table 3 and Section 2.
2. Series termination resistor is not needed for this configuration. Output impedance is 50 Ω for the indicated supply condition.
3. Series termination resistor is not needed for this configuration. Reduced EMI setting.
4. Silicon Labs 3.2 x 5 mm package is delivered as 3.2 x 4 mm and accommodates the industry-standard 3.2 x 5 mm footprint.
5. The Si502 OE pin has three (3) states: OE High = Freq 1; OE Weak High = Freq 2; OE Low is configurable.

Figure 11. Si502 Part Number Syntax

5.3. Si503 Ordering Guide and Part Number Syntax



Note:

1. Series termination resistor (R_S) is recommended for this configuration. See Table 3 and Section 2.
2. Series termination resistor is not needed for this configuration. Output impedance is 50 Ω for the indicated supply condition.
3. Series termination resistor is not needed for this configuration. Reduced EMI setting.
4. Silicon Labs 3.2 x 5 mm package is delivered as 3.2 x 4 mm and accommodates the industry-standard 3.2 x 5 mm footprint.

Figure 12. Si503 Part Number Syntax

6. Package Dimensions and Land Patterns

6.1. Package Outline: 3.2 x 5 mm 4-pin DFN



Note: Layout and pin-compatible with industry-standard 3.2 x 5 mm footprint.

Figure 13. 3.2 x 5 mm 4-pin DFN

6.2. Package Outline: 2.5 x 3.2 mm 4-pin DFN



Figure 14. 2.5 x 3.2 mm 4-pin DFN

6.3. Package Outline: 2 x 2.5 mm 4-pin DFN

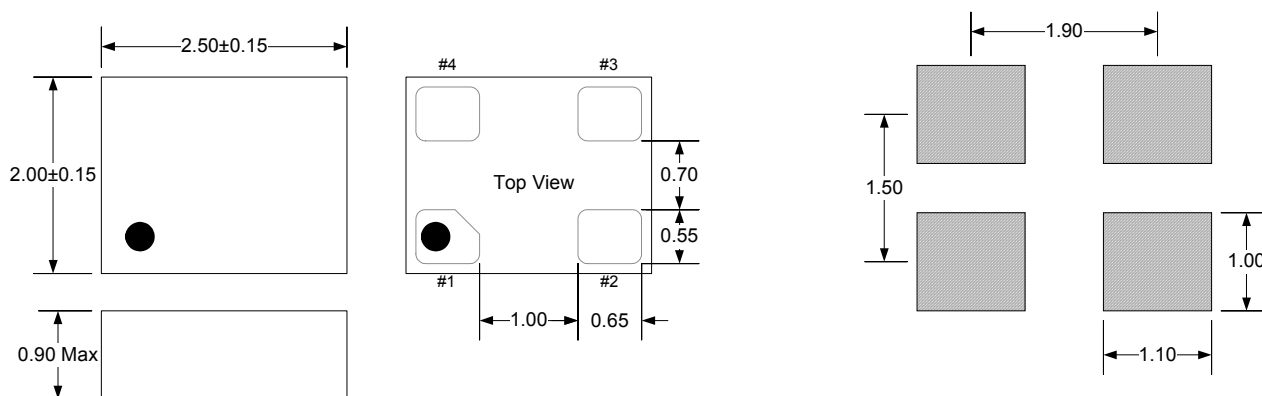


Figure 15. 2 x 2.5 mm 4-pin DFN

7. Top Markings

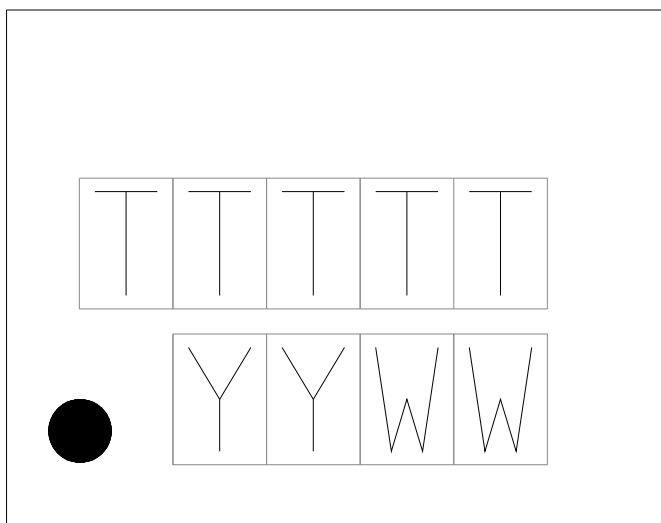
7.1. 3.2 x 5 mm Top Marking



7.2. 3.2 x 5 mm Top Marking Explanation

Mark Method:	Laser	
Font Size:	0.60 mm Right-Justified	
Line 1 Marking:	TTTTTT=Trace Code	Manufacturing Code from the Assembly Purchase Order form.
Line 2 Marking	Circle=0.5 mm Diameter Left-Justified	Pin 1 Indicator
	YY=Year WW=Work Week	Assigned by the Assembly House. Corresponds to the year and work week of the build date.

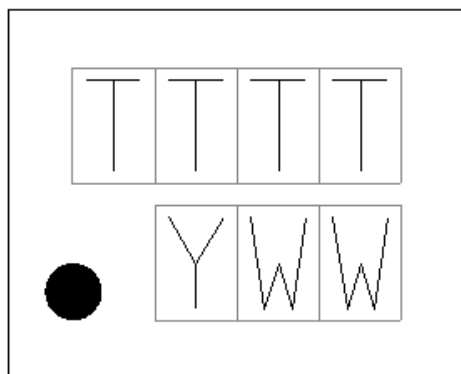
7.3. 2.5 x 3.2 mm Top Marking



7.4. 2.5 x 3.2 mm Top Marking Explanation

Mark Method:	Laser	
Font Size:	0.50 mm Right-Justified	
Line 1 Marking:	TTTTT=Trace Code	Manufacturing Code from the Assembly Purchase Order form.
Line 2 Marking:	Circle=0.3 mm Diameter Left-Justified	Pin 1 Indicator
	Y=Year WW=Work Week	Assigned by the Assembly House. Corresponds to the year and work week of the build date.

7.5. 2 x 2.5 mm Top Marking



7.6. 2 x 2.5 mm Top Marking Explanation

Mark Method:	Laser	
Font Size:	0.50 mm Right-Justified	
Line 1 Marking:	TTTT=Trace Code	Manufacturing Code from the Assembly Purchase Order form.
Line 2 Marking:	Circle=0.3 mm Diameter Left-Justified	Pin 1 Indicator
	Y=Year WW=Work Week	Assigned by the Assembly House. Corresponds to the year and work week of the build date.

DOCUMENT CHANGE LIST**Revision 0.2 to Revision 0.3**

- Combined Si501/2/3 data sheets.
- Modified title page.
- Modified Table 2.
- Modified Table 4.
- Modified Section 2.
- Modified Section 3.
- Modified Section 4.
- Modified Section 5.

Revision 0.3 to Revision 0.4

- Modified title page.
- Modified Table 1.
- Modified Table 2.
- Modified Table 3.
- Modified Table 4.
- Modified Table 5.
- Modified Table 6.
- Modified Table 7.
- Modified Section 2.
- Modified Section 4.
- Modified Section 5.
- Modified Section 6.

Revision 0.4 to Revision 0.41

- Modified Table 4.

Revision 0.41 to Revision 0.7

- Revised supported frequency range.
- Added MIN/MAX figures to all relevant tables.

Revision 0.7 to Revision 0.71

- Revised Table 3.
- Revised Section 5.

Revision 0.71 to Revision 0.72

- Revised Table 1.
- Revised Table 2.
- Revised Table 3.
- Revised Table 5.
- Modified Section 2.
- Added Section 3.
- Modified Section 4.

Revision 0.72 to Revision 1.0

- Updated Table 3.
- Updated Section 6.

CONTACT INFORMATION

Silicon Laboratories Inc.

400 West Cesar Chavez
Austin, TX 78701
Tel: 1+(512) 416-8500
Fax: 1+(512) 416-9669
Toll Free: 1+(877) 444-3032

Please visit the Silicon Labs Technical Support web page:
<https://www.siliconlabs.com/support/pages/contacttechnicalsupport.aspx>
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